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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are Embedded - System On Chip (SoC)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details	
Product Status	Obsolete
Architecture	MCU, FPGA
Core Processor	Dual ARM® Cortex®-A9 MPCore™ with CoreSight™
Flash Size	-
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I²C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	700MHz
Primary Attributes	FPGA - 350K Logic Elements
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FBGA, FC (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5asxfb3h4f40c6n

Feature	Description	

Embedded Hard IP blocks	Variable-precision DSP	• Native support for up to four signal processing precision levels:
		
		  • Three 9 x 9, two 18 x 18, or one 27 x 27 multiplier in the same variable-precision DSP block
		  • One 36 x 36 multiplier using two variable-precision DSP blocks (Arria V GZ devices only)
		• 64-bit accumulator and cascade for systolic finite impulse responses (FIRs)
		• Embedded internal coefficient memory
		• Preadder/subtractor for improved efficiency

	Memory controller (Arria V GX, GT, SX, and ST only)	DDR3 and DDR2

	Embedded transceiver I/O	• Custom implementation:
		
		  • Arria V GX and SX devices—up to 6.5536 Gbps
		  • Arria V GT and ST devices—up to 10.3125 Gbps
		  • Arria V GZ devices—up to 12.5 Gbps
		• PCI Express® (PCIe®) Gen2 (x1, x2, or x4) and Gen1 (x1, x2, x4, or x8) hard IP with multifunction support, endpoint, and root port
		• PCIe Gen3 (x1, x2, x4, or x8) support (Arria V GZ only)
		• Gbps Ethernet (GbE) and XAUI physical coding sublayer (PCS)
		• Common Public Radio Interface (CPRI) PCS
		• Gigabit-capable passive optical network (GPON) PCS
		• 10-Gbps Ethernet (10GbE) PCS (Arria V GZ only)
		• Serial RapidIO® (SRIO) PCS
		• Interlaken PCS (Arria V GZ only)

Clock networks	• Up to 650 MHz global clock network • Global, quadrant, and peripheral clock networks • Clock networks that are not used can be powered down to reduce dynamic power	
Phase-locked loops (PLLs)	• High-resolution fractional PLLs • Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) • Integer mode and fractional mode • LC oscillator ATX transmitter PLLs (Arria V GZ only)	

Feature	Description
FPGA General-purpose I/Os (GPIOs)	• 1.6 Gbps LVDS receiver and transmitter • 800 MHz/1.6 Gbps external memory interface • On-chip termination (OCT) • 3.3 V support [2]
External Memory Interface	Memory interfaces with low latency: • Hard memory controller-up to 1.066 Gbps • Soft memory controller-up to 1.6 Gbps
Low-power high-speed serial interface	• 600 Mbps to 12.5 Gbps integrated transceiver speed • Less than 105 mW per channel at 6 Gbps, less than 165 mW per channel at 10 Gbps, and less than 170 mW per channel at 12.5 Gbps • Transmit pre-emphasis and receiver equalization • Dynamic partial reconfiguration of individual channels • Physical medium attachment (PMA) with soft PCS that supports 9.8304 Gbps CPRI (Arria V GT and ST only) • PMA with hard PCS that supports up to 9.8 Gbps CPRI (Arria V GZ only) • Hard PCS that supports 10GBASE-R and 10GBASE-KR (Arria V GZ only)
HPS (Arria V SX and ST devices only)	• Dual-core ARM Cortex-A9 MPCore processor—up to 1.05 GHz maximum frequency with support for symmetric and asymmetric multiprocessing • Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, serial peripheral interface (SPI), I2C interface, and up to 85 HPS GPIO interfaces • System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers • On-chip RAM and boot ROM • HPS–FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa • FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller • ARM CoreSight™ JTAG debug access port, trace port, and on-chip trace storage

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[2] Arria V GZ devices support 3.3 V with a 3.0 V V_{CCIO}.

Resource		A1	A3	A5	A7	B1	B3	B5	B7
		Member Code							
6 Gbps Transceiver		9	9	24	24	24	24	36	36
GPIO[3]		416	416	544	544	704	704	704	704
LVDS	Transmitter	67	67	120	120	160	160	160	160
	Receiver	80	80	136	136	176	176	176	176
PCIe Hard IP Block		1	1	2	2	2	2	2	2
Hard Memory Controller		2	2	4	4	4	4	4	4

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

Package Plan

Table 5: Package Plan for Arria V GX Devices

Member Code	F672 (27 mm)		F896 (31 mm)		F1152 (35 mm)		F1517 (40 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
A1	336	9	416	9	—	—	—	—
A3	336	9	416	9	—	—	—	—
A5	336	9	384	18	544	24	—	—
A7	336	9	384	18	544	24	—	—
B1	—	—	384	18	544	24	704	24
B3	—	—	384	18	544	24	704	24
B5	—	—	—	—	544	24	704	36
B7	—	—	—	—	544	24	704	36

Arria V GT

This section provides the available options, maximum resource counts, and package plan for the Arria V GT devices.

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[3] The number of GPIOs does not include transceiver I/Os. In the Quartus® Prime software, the number of user I/Os includes transceiver I/Os.

Resource		C3	C7	D3	D7
		Member Code			
Transceiver	6 Gbps[4]	3 (9)	6 (24)	6 (24)	6 (36)
	10 Gbps[5]	4	12	12	20
GPIO[6]		416	544	704	704
LVDS	Transmitter	68	120	160	160
	Receiver	80	136	176	176
PCIe Hard IP Block		1	2	2	2
Hard Memory Controller		2	4	4	4

Related Information

- **High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook**
  Provides the number of LVDS channels in each device package.
- **Transceiver Architecture in Arria V Devices**
  Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

Package Plan

Table 7: Package Plan for Arria V GT Devices

Member Code	F672 (27 mm)			F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	GPIO	XCVR		GPIO	XCVR		GPIO	XCVR		GPIO	XCVR	
		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps		6-Gbps	10-Gbps
C3	336	3 (9)	4	416	3 (9)	4	—	—	—	—	—	—
C7	—	—	—	384	6 (18)	8	544	6 (24)	12	—	—	—
D3	—	—	—	384	6 (18)	8	544	6 (24)	12	704	6 (24)	12
D7	—	—	—	—	—	—	544	6 (24)	12	704	6 (36)	20

The 6-Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10-Gbps channels as three 6-Gbps channels—the total number of 6-Gbps channels are shown in brackets. For example, you can also configure the Arria V GT D7 device in the F1517 package with nine 6-Gbps

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[4] The 6 Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10 Gbps channels as three 6 Gbps channels-the total number of 6 Gbps channels are shown in brackets.

[5] Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

[6] The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

and eighteen 10-Gbps, twelve 6-Gbps and sixteen 10-Gbps, fifteen 6-Gbps and fourteen 10-Gbps, or up to thirty-six 6-Gbps with no 10-Gbps channels.

Arria V GZ

This section provides the available options, maximum resource counts, and package plan for the Arria V GZ devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.
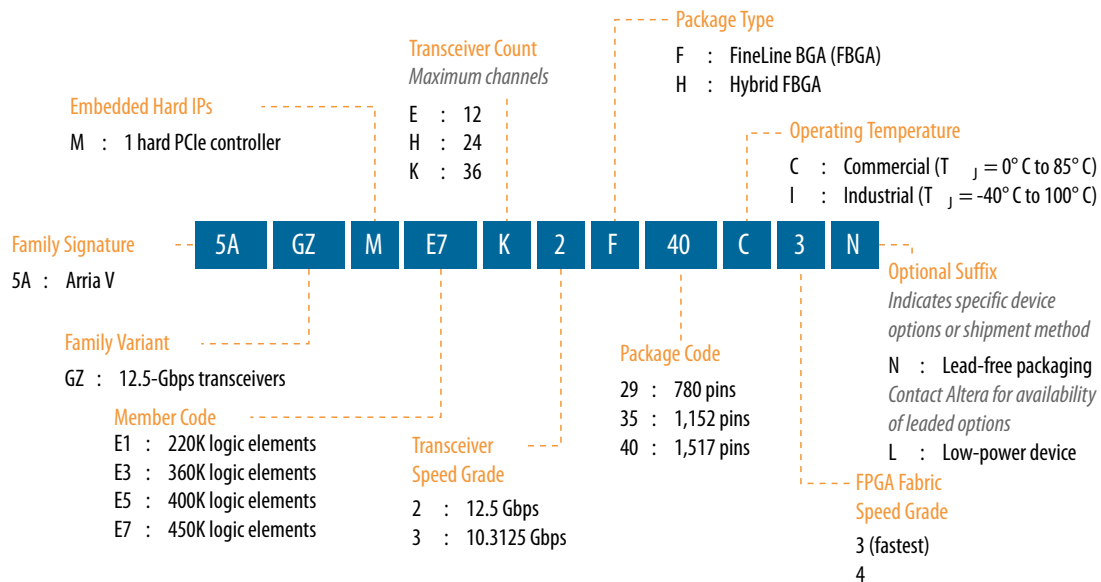
Related Information
Altera Product Selector
Provides the latest information about Altera products.

Available Options

Figure 3: Sample Ordering Code and Available Options for Arria V GZ Devices

Note: Low-power device option is available only for −3 speed grade at industrial temperature

Maximum Resources

Table 8: Maximum Resource Counts for Arria V GZ Devices

Resource	Member Code			
	E1	E3	E5	E7
Logic Elements (LE) (K)	220	360	400	450
ALM	83,020	135,840	150,960	169,800
Register	332,080	543,360	603,840	679,200

Resource		Member Code	
		B3	B5
FPGA PLL		14	14
HPS PLL		3	3
6 Gbps Transceiver		30	30
FPGA GPIO[8]		540	540
HPS I/O		208	208
LVDS	Transmitter	120	120
	Receiver	136	136
PCIe Hard IP Block		2	2
FPGA Hard Memory Controller		3	3
HPS Hard Memory Controller		1	1
ARM Cortex-A9 MPCore Processor		Dual-core	Dual-core

Related Information

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

Package Plan

Table 11: Package Plan for Arria V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	F896 (31 mm)			F1152 (35 mm)			F1517 (40 mm)		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
B3	250	208	12	385	208	18	540	208	30
B5	250	208	12	385	208	18	540	208	30

Arria V ST

This section provides the available options, maximum resource counts, and package plan for the Arria V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

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[8] The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

Resource		Member Code	
		D3	D5
FPGA GPIO[10]		540	540
HPS I/O		208	208
LVDS	Transmitter	120	120
	Receiver	136	136
PCIe Hard IP Block		2	2
FPGA Hard Memory Controller		3	3
HPS Hard Memory Controller		1	1
ARM Cortex-A9 MPCore Processor		Dual-core	Dual-core

Related Information

- **High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook**
  Provides the number of LVDS channels in each device package.
- **Transceiver Architecture in Arria V Devices**
  Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

Package Plan

Table 13: Package Plan for Arria V ST Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	F896 (31 mm)				F1152 (35 mm)				F1517 (40 mm)			
	FPGA GPIO	HPS I/O	XCVR		FPGA GPIO	HPS I/O	XCVR		FPGA GPIO	HPS I/O	XCVR	
			6 Gbps	10 Gbps			6 Gbps	10 Gbps			6 Gbps	10 Gbps
D3	250	208	12	6	385	208	18	8	540	208	30	16
D5	250	208	12	6	385	208	18	8	540	208	30	16

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[9] Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

[10] The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

I/O Vertical Migration for Arria V Devices

Figure 6: Vertical Migration Capability Across Arria V Device Packages and Densities

The arrows indicate the vertical migration paths. Some packages have several migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.

Variant	Member Code	Package				
		F672	F780	F896	F 1152	F1517
Arria V GX	A1					
	A3					
	A5					
	A7					
	B1					
	B3					
	B5					
	B7					
Arria V GT	C3					
	C7					
	D3					
	D7					
Arria V GZ	E1					
	E3					
	E5					
	E7					
Arria V SX	B3					
	B5					
Arria V ST	D3					
	D5					

You can achieve the vertical migration shaded in red if you use only up to 320 GPIOs, up to nine 6 Gbps transceiver channels, and up to four 10 Gbps transceiver (for Arria V GT devices). This migration path is not shown in the Quartus Prime software Pin Migration View.

Note: To verify the pin migration compatibility, use the Pin Migration View window in the Quartus Prime software Pin Planner.

Note: Except for Arria V GX A5 and A7, and Arria V GT C7 devices, all other Arria V GX and GT devices require a specific power-up sequence. If you plan to migrate your design from Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices, your design must adhere to the same required power-up sequence.
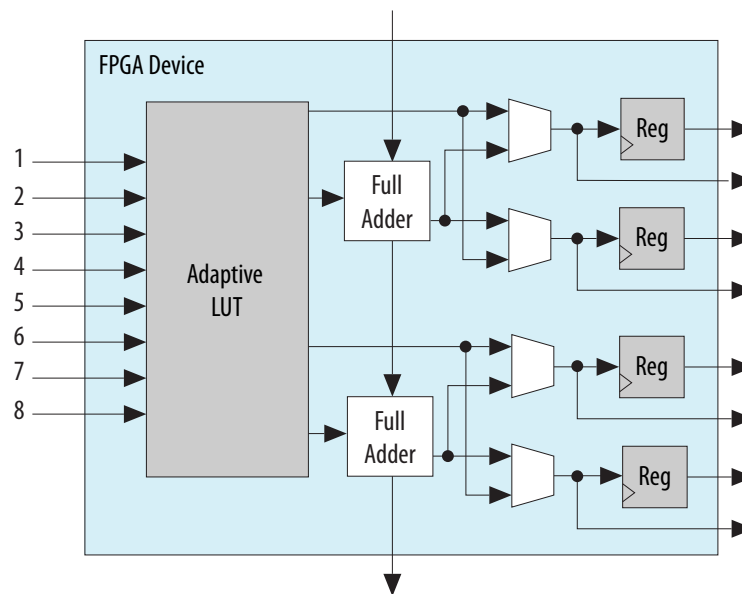
Related Information

- **Managing Device I/O Pins chapter, Quartus Prime Handbook**
  Provides more information about vertical I/O migrations.
- **Power Management in Arria V Devices**
  Describes the power-up sequence required for Arria V GX and GT devices.

Adaptive Logic Module

Arria V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.

Figure 7: ALM for Arria V Devices

You can configure up to 50% of the ALMs in the Arria V devices as distributed memory using MLABs.

Related Information

Embedded Memory Capacity in Arria V Devices on page 20
Lists the embedded memory capacity for each device.

Variable-Precision DSP Block

Arria V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18, 27 x 27, and 36 x 36 bits natively
- A 64-bit accumulator
- Double accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Dynamic coefficients
- 18-bit internal coefficient register banks
- Enhanced independent multiplier operation
- Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Quartus Prime design software

Table 14: Variable-Precision DSP Block Configurations for Arria V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters	Two 18 x 18 with accumulate	1
Single-precision floating-point implementations	One 27 x 27	1
Very high precision fixed point implementations	One 36 x 36	2

You can configure each DSP block during compilation as independent three 9 x 9, two 18 x 18, or one 27 x 27 multipliers. Using two DSP block resources, you can also configure a 36 x 36 multiplier for high-precision applications. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

Table 15: Number of Multipliers in Arria V Devices

The table lists the variable-precision DSP resources by bit precision for each Arria V device.

Variant	Member Code	Variable-precision DSP Block	Independent Input and Output Multiplications Operator				18 x 18 Multiplier Adder Mode	18 x 18 Multiplier Adder Summed with 36 bit Input
			9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	36 x 36 Multiplier		
Arria V GX	A1	240	720	480	240	—	240	240
	A3	396	1,188	792	396	—	396	396
	A5	600	1,800	1,200	600	—	600	600
	A7	800	2,400	1,600	800	—	800	800
	B1	920	2,760	1,840	920	—	920	920
	B3	1,045	3,135	2,090	1,045	—	1,045	1,045
	B5	1,092	3,276	2,184	1,092	—	1,092	1,092
	B7	1,156	3,468	2,312	1,156	—	1,156	1,156
Arria V GT	C3	396	1,188	792	396	—	396	396
	C7	800	2,400	1,600	800	—	800	800
	D3	1,045	3,135	2,090	1,045	—	1,045	1,045
	D7	1,156	3,468	2,312	1,156	—	1,156	1,156
Arria V GZ	E1	800	2,400	1,600	800	400	800	800
	E3	1,044	3,132	2,088	1,044	522	1,044	1,044
	E5	1,092	3,276	2,184	1,092	546	1,092	1,092
	E7	1,139	3,417	2,278	1,139	569	1,139	1,139
Arria V SX	B3	809	2,427	1,618	809	—	809	809
	B5	1,090	3,270	2,180	1,090	—	1,090	1,090
Arria V ST	D3	809	2,427	1,618	809	—	809	809
	D5	1,090	3,270	2,180	1,090	—	1,090	1,090

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

Types of Embedded Memory

The Arria V devices contain two types of memory blocks:

- 20 Kb M20K or 10 Kb M10K blocks—blocks of dedicated memory resources. The M20K and M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Arria V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB. You can also configure these ALMs, in Arria V GZ devices, as ten 64 x 1 blocks, giving you one 64 x 10 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Arria V Devices

Table 16: Embedded Memory Capacity and Distribution in Arria V Devices

Variant	Member Code	M20K		M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Arria V GX	A1	—	—	800	8,000	741	463	8,463
	A3	—	—	1,051	10,510	1538	961	11,471
	A5	—	—	1,180	11,800	1877	1,173	12,973
	A7	—	—	1,366	13,660	2317	1,448	15,108
	B1	—	—	1,510	15,100	2964	1,852	16,952
	B3	—	—	1,726	17,260	3357	2,098	19,358
	B5	—	—	2,054	20,540	4052	2,532	23,072
	B7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GT	C3	—	—	1,051	10,510	1538	961	11,471
	C7	—	—	1,366	13,660	2317	1,448	15,108
	D3	—	—	1,726	17,260	3357	2,098	19,358
	D7	—	—	2,414	24,140	4650	2,906	27,046
Arria V GZ	E1	585	11,700	—	—	4,151	2,594	14,294
	E3	957	19,140	—	—	6,792	4,245	23,385
	E5	1,440	28,800	—	—	7,548	4,718	33,518
	E7	1,700	34,000	—	—	8,490	5,306	39,306
Arria V SX	B3	—	—	1,729	17,290	3223	2,014	19,304
	B5	—	—	2,282	22,820	4253	2,658	25,478

Variant	Member Code	M20K		M10K		MLAB		Total RAM Bit (Kb)
		Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	
Arria V ST	D3	—	—	1,729	17,290	3223	2,014	19,304
	D5	—	—	2,282	22,820	4253	2,658	25,478

Embedded Memory Configurations

Table 17: Supported Embedded Memory Block Configurations for Arria V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20
	64[11]	x10
M20K	512	x40
	1K	x20
	2K	x10
	4K	x5
	8K	x2
	16K	x1
M10K	256	x40 or x32
	512	x20 or x16
	1K	x10 or x8
	2K	x5 or x4
	4K	x2
	8K	x1

Clock Networks and PLL Clock Sources

650 MHz Arria V devices have 16 global clock networks capable of up to operation. The clock network architecture is based on Altera's global, quadrant, and peripheral clock structure. This clock structure is supported by dedicated clock input pins and fractional PLLs.

Note: To reduce power consumption, the Quartus Prime software identifies all unused sections of the clock network and powers them down.

[11] Available for Arria V GZ devices only.

PCIe Gen1, Gen2, and Gen 3 Hard IP

Arria V devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen3, Gen 2, and Gen 1 end point and root port for up to x8 lane configuration.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

Figure 8: PCIe Multifunction for Arria V Devices
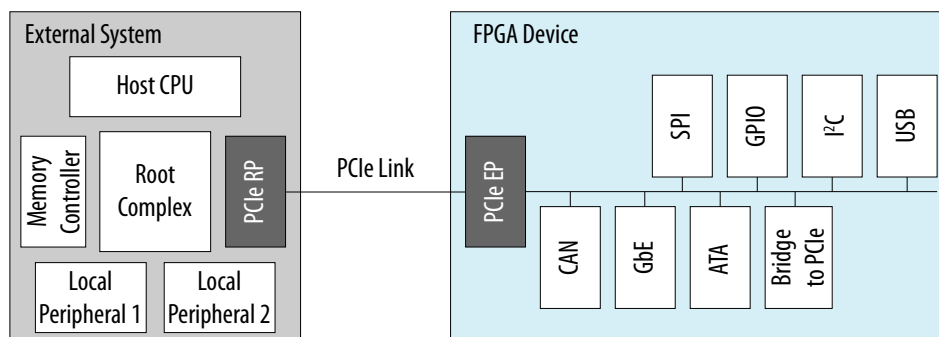
The Arria V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Arria V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Arria V device provides improved end-to-end datapath protection using ECC.

External Memory Interface

This section provides an overview of the external memory interface in Arria V devices.

Hard and Soft Memory Controllers

Arria V GX,GT, SX, and ST devices support up to four hard memory controllers for DDR3 and DDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Arria V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Arria V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices, QDR II+, QDR II, and DDR II+ SRAM devices, and RLDRAM II devices for maximum flexibility.

Note: DDR3 SDRAM leveling is supported only in Arria V GZ devices.

Related Information

External Memory Interface Spec Estimator
For the latest information and to estimate the external memory system performance specification, use
Altera's External Memory Interface Spec Estimator tool.

Low-Power Serial Transceivers

Arria V devices deliver the industry's lowest power consumption per transceiver channel:

- 12.5 Gbps transceivers at less than 170 mW
- 10 Gbps transceivers at less than 165 mW
- 6 Gbps transceivers at less than 105 mW

Arria V transceivers are designed to be compliant with a wide range of protocols and data rates.

Transceiver Channels

The transceivers are positioned on the left and right outer edges of the device. The transceiver channels
consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.

The following figures are graphical representations of a top view of the silicon die, which corresponds to a
reverse view for flip chip packages. Different Arria V devices may have different floorplans than the ones
shown in the figures.

PCS Support[13]	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
PCIe Gen1 (x1, x2, x4, x8) PCIe Gen2[14] (x1, x2, x4)	2.5 and 5.0	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • PIPE 2.0 interface to the core logic	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO • Rate match FIFO • PIPE 2.0 interface to the core logic
GbE	1.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO • Rate match FIFO
XAUI[15]	3.125	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • XAUI state machine for bonding four channels	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO • XAUI state machine for realigning four channels • Deskew FIFO circuitry
SDI	0.27[16], 1.485, 2.97	• Phase compensation FIFO • Byte serializer	• Byte deserializer • Phase compensation FIFO
GPON[17]	1.25 and 2.5		
CPRI[18]	0.6144 to 6.144	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • TX deterministic latency	• Word aligner • 8B/10B decoder • Byte deserializer • Phase compensation FIFO • RX deterministic latency

[13] Data rates above 6.5536 Gbps up to 10.3125 Gbps, such as 10GBASE-R, are supported through the soft PCS.

[14] PCIe Gen2 is supported only through the PCIe hard IP.

[15] XAUI is supported through the soft PCS.

[16] The 0.27 Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

[17] The GPON standard does not support burst mode.

[18] CPRI data rates above 6.5536 Gbps, such as 9.8304 Gbps, are supported through the soft PCS.

Table 22: Transceiver PCS Features for Arria V GZ Devices

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
Custom PHY	0.6 to 9.80	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering
GPON	1.25 and 2.5		
Custom 10G PHY	9.98 to 12.5	• TX FIFO • Gear box • Bit-slip	• RX FIFO • Gear box
PCIe Gen1 (x1, x2 x4, x8)	2.5 and 5.0	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • PIPE 2.0 interface to core logic	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer, • Byte ordering • PIPE 2.0 interface to core logic
PCIe Gen2 (x1, x2, x4, x8)			
PCIe Gen3 (x1, x2, x4, x8)	8.0	• Phase compensation FIFO • 128B/130B encoder • Scrambler • Gear box • Bit-slip	• Block synchronization • Rate match FIFO • 128B/130B decoder • Descrambler • Phase compensation FIFO
10GbE	10.3125	• TX FIFO • 64B/66B encoder • Scrambler • Gear box	• RX FIFO • 64B/66B decoder • Descrambler • Block synchronization • Gear box
Interlaken	3.125 to 12.5	• TX FIFO • Frame generator • CRC-32 generator • Scrambler • Disparity generator • Gear box	• RX FIFO • Frame generator • CRC-32 checker • Frame decoder • Descrambler • Disparity checker • Block synchronization • Gear box

Protocol	Data Rates (Gbps)	Transmitter Data Path Features	Receiver Data Path Features
40GBASE-R Ethernet	4 x 10.3125	• TX FIFO • 64B/66B encoder • Scrambler • Alignment marker insertion • Gearbox • Block stripper	• RX FIFO • 64B/66B decoder • Descrambler • Lane reorder • Deskew • Alignment marker lock • Block synchronization • Gear box • Destripper
100GBASE-R Ethernet	10 x 10.3125		
40G and 100G OTN	(4 +1) x 11.3 (10 +1) x 11.3	• TX FIFO • Channel bonding • Byte serializer	• RX FIFO • Lane deskew • Byte deserializer
GbE	1.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • GbE state machine	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • GbE state machine
XAUI	3.125 to 4.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • XAUI state machine for bonding four channels	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • XAUI state machine for realigning four channels
SRIO	1.25 to 6.25	• Phase compensation FIFO • Byte serializer • 8B/10B encoder • Bit-slip • Channel bonding • SRIO V2.1-compliant x2 and x4 channel bonding	• Word aligner • Deskew FIFO • Rate match FIFO • 8B/10B decoder • Byte deserializer • Byte ordering • SRIO V2.1-compliant x2 and x4 deskew state machine

Document Revision History

Date	Version	Changes
December 2015	2015.12.21	• Updated RoHS and optional suffix information in sample ordering code and available options diagrams for Arria V GX and GT devices. • Changed instances of *Quartus II* to *Quartus Prime*.
January 2015	2015.01.23	• Updated package dimension for Arria V GZ H780 package from 29 mm to 33 mm. • Updated dual-core ARM Cortex-A9 MPCore processor maximum frequency from 800 MHz to 1.05 GHz.
December 2013	2013.12.26	• 10-Gbps Ethernet (10GbE) PCS and Interlaken PCS are for Arria V GZ only. • Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables. • Added link to **Altera Product Selector** for each device variant. • Added leaded package options. • Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F896 package from 170 to 250. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1152 package from 350 to 385. • Corrected FPGA GPIO for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 F1517 package from 528 to 540. • Corrected LVDS Transmitter for Arria V SX B3 and B5 as well as Arria V ST D3 and D5 devices from 121 to 120. • Added links to Altera's **External Memory Spec Estimator** tool to the topics listing the external memory interface performance. • Added x2 for PCIe Gen3, Gen 2, and Gen 1.
August 2013	2013.08.19	• Removed the note about the PCIe hard IP on the right side of the device in the F896 package of the Arria V GX variant. These devices do not have PCIe hard IP on the right side. • Added transceiver speed grade 6 to the available options of the Arria V SX variant. • Corrected the maximum LVDS transmitter channel counts for the Arria V GX A1 and A3 devices from 68 to 67. • Corrected the maximum FPGA GPIO count for Arria V ST D5 devices from 540 to 528.

Date	Version	Changes
July 2012	2.1	• Added –I3 speed grade to Figure 1 for Arria V GX devices. • Updated the 6-Gbps transceiver speed from 6.553 Gbps to 6.5536 Gbps in Figure 3 and Figure 1.
June 2012	2.0	• Restructured the document. • Added the "Embedded Memory Capacity" and "Embedded Memory Configurations" sections. • Added Table 1, Table 3, Table 12, Table 15, and Table 16. • Updated Table 2, Table 4, Table 5, Table 6, Table 7, Table 8, Table 9, Table 10, Table 11, Table 13, Table 14, and Table 19. • Updated Figure 1, Figure 2, Figure 3, Figure 4, and Figure 8. • Updated the "FPGA Configuration and Processor Booting" and "Hardware and Software Development" sections. • Text edits throughout the document.
February 2012	1.3	• Updated Table 1–7 and Table 1–8. • Updated Figure 1–9 and Figure 1–10. • Minor text edits.
December 2011	1.2	Minor text edits.
November 2011	1.1	• Updated Table 1–1, Table 1–2, Table 1–3, Table 1–4, Table 1–6, Table 1–7, Table 1–9, and Table 1–10. • Added "SoC FPGA with HPS" section. • Updated "Clock Networks and PLL Clock Sources" and "Ordering Information" sections. • Updated Figure 1–5. • Added Figure 1–6. • Minor text edits.
August 2011	1.0	Initial release.